IEEE P802.3ds 200 Gb/s per Wavelength MMF PHYs Task Force

Unapproved Meeting Minutes, prepared by Guangcan Mi, Secretary and Mabud Choudhury, Chair of the IEEE P802.3ds 200 Gb/s per Wavelength MMF PHYs TF

12-13 May 2026, IEEE P802.3ds TF May 2026 Interim Meeting
Location: Munich, Germany / Hybrid

IEEE P802.3ds 200 Gb/s per Wavelength MMF PHYs Task Force May Interim Meeting Page: https://www.ieee802.org/3/ds/public/Interim_May_12-13-2026

Day 1
Meeting called to order at 1:15 p.m. Central European Summer Time (CEST, UTC +2) by Mabud Choudhury, Chair of the IEEE P802.3ds 200 Gb/s per Wavelength MMF PHYs TF.

Chair reminded participants to declare their name and affiliation in the online meeting tool. Failure to declare would result in expulsion from the meeting.

Agenda and General information
Chair reviewed the Chair's slides, agenda_3ds_01_2605.pdf

Chair presented the agenda of the meeting (see slide 3). Chair asked if anyone had any updates or modifications to the agenda. There were none. Chair made motion to approve the agenda. The agenda was approved by unanimous consent (1.19 p.m.).

Chair asked if there were any modifications, additions or deletions to the unapproved minutes for the 07 May Interim meeting minutes that had been previously posted (see slide 4). There were none. Chair made motion to approve the unapproved meeting minute listed. The motion passed by unanimous consent (1.19 p.m.).

Chair reviewed the decorum of the meeting (see slides 5-7).
No recording or AI agent is allowed in the meeting. Chair asked if there were any members of the press present. There were none.

Chair reviewed the goals of this meeting (see slide 8).
Chair reviewed the big ticket items of this meeting (see slide 9).
Chair reviewed project information of P802.3ds TF (see slide 10).

Chair provided access information to the private area of the Task Force (see slide 11). The TF private area username and password were shown in the meeting only. Anyone requiring the username and password can contact the TF Chair and Secretary.

Chair reviewed IEEE 802.3 ground rules (see slide 12.)

IMAT reminder (1:27 p.m.)
The chair asked that eligible participants should sign in to IMAT to claim Working Group attendance credit, and that meeting attendance would be taken from IMAT. (see Agenda slide #1). He noted that participants not eligible to sign in to IMAT to claim Working Group

attendance credit are to send an email to Mabud Choudhury/Guangcan Mi to be recorded in the meeting minutes. Chair asked the Recording Secretary to put IMAT information in the chat window.

Chair presented Voting rules (see slide 14). May 2026 P802.3ds TF Interim Meeting is an electronic meeting, as announced https://www.ieee802.org/3/email_dialog/msg01812.html by the TF Chair.
In such electronic meetings only IEEE 802.3 Working Group members may make and vote on motions. If a motion is not approved by unanimous consent, it shall be taken as a roll call vote. All participants who feel qualified may participate in a straw poll. Note – Chair reserves the right to take informative straw polls by 802.3 WG voting membership.

Chair presented access information to IEEE bylaws and rules in slide 16.

By presenting slides 18-21, Chair reviewed patent policies of IEEE with the participants. Call for essential patents was made at 1:30 p.m. No one indicated that they had essential patents.

Chair presented the IEEE SA Copyright Policy information (see slides 22-24). Chair noted – "By participating in this activity, you agree to comply with the IEEE Code of Ethics, all applicable laws, and all IEEE policies and procedures including, but not limited to, the IEEE SA Copyright Policy."

Chair presented IEEE SA Participation Policy information (see slides 25-28).

Chair noted – "Participants in the IEEE-SA 'individual process' shall act independently of others, including employers." "By participating in standards activities using the 'individual process', you are deemed to accept these requirements; if you are unable to satisfy these requirements then you shall immediately cease any participation." (see slide 26).

Chair presented that IEEE SA standards activities shall allow the fair & equitable consideration of all viewpoints (see slide 27).

Chair provided information for IEEE Ethics Reporting Line (see slide 29).

Chair reviewed the IEEE 802.3 standard process and presented the status of 802.3ds Task Force (see slides 30~34).

Chair reviewed the adopted objectives of 802.3ds TF (see slide 35).

Chair reviewed the adopted timeline with the Task Force (see slides 36~37).

Chair presented the liaison report for this Interim meeting (see slide 38).

Chair presented the presentations and meeting map for this Interim meeting (see slide 39).

Chair presented the future meetings information to the Task Force. (see slides 40-41).

IMAT reminder
Chair asked the Recording Secretary to put IMAT information in the chat window (1:45 p.m.).

Presentation #1

Title	P802.3ds Editors' Report
Presenter	Ramana Murty
URL	editors_report_3ds_01a_2605.pdf

Questions were asked and answered.

Liaisons & Communications

Title	IEC TC86 to IEEE 802.3 Liaison Report
Presenter	Mike Ransford (for Vince Ferretti)
URL	IEC_TC86_to_IEEE_802d3_Liaison_Report.pdf

Questions were asked and answered.

Secretary of IEC TC86 attended the Interim meeting and provided further information regarding the plan of IEC TC86 to address the new MMF needs.

Presentation #3

Title	Proposed 1060 nm baseline
Presenter	David Lewis
URL	lewis_3ds_01a_2605.pdf

Questions were asked and answered. An updated version was provided after the meeting.

Motion # 3 **Move to adopt the 1060 nm baseline:** I support adoption of the 1060 nm baseline based on lewis_3ds_01a_2605, using the values provided in Tables on Slides #4 through #7, with editorial license.
By rulel (>= 75%)
Moved by David Lewis
Second by Roberto Rodes
Passed by unanimous consent. 2:27 p.m.

Comment resolution began at 2:30 p.m.

Presentation #4

Title	Outer Optical Modulation Amplitude and Tx Average Launch Power (in support of comments #13, #14, and #15)
Presenter	Eric Bernier
URL	bernier_3ds_01_2605.pdf

Questions were asked and answered.

IMAT reminder
Chair reminded participants that meeting attendance will be recorded using the IMAT tool. (12:19 PM).

Comment resolution was recessed at 3:17 PM. Comment resolution will resume in PM2 session of the 13 May meeting.

Meeting recessed at 3:17 PM CEST for the day.

Day 2

Meeting resumed at 2:32p.m. CEST.

Presentation #5

Title	P802.3ds Editors' Report
Presenter	Ramana Murty
URL	editors_report_3ds_01a_2605.pdf

Questions were asked and answered.

IMAT reminder (2:38 p.m.)
The chair asked that eligible participants should sign in to IMAT to claim Working Group attendance credit, and that meeting attendance would be taken from IMAT. (see Agenda slide #1). He noted that participants not eligible to sign in to IMAT to claim Working Group attendance credit are to send an email to Mabud Choudhury/Guangcan Mi to be recorded in the meeting minutes. Chair asked the Recording Secretary to put IMAT information in the chat window.

Comment resolution resumed at 2:39 p.m.

Straw Poll #1 Comment #37	
For TDECQ measurement histogram I support adopting: **A:** Keep current draft parameter (spacing 0.08UI and width 0.04UI) and the note (spacing 0.1UI and width 0.02UI) **B:** Window spacing 0.08UI and width 0.04UI (current draft without the note) **C:** Window spacing 0.09UI and width 0.02UI (commenter's proposal without the note)	
All (a/b/c)	A: 2, B: 2, C: 10

IMAT reminder (5:20 p.m.)
The chair asked that eligible participants should sign in to IMAT to claim Working Group attendance credit, and that meeting attendance would be taken from IMAT.

Chair presented the future meetings information to the Task Force. (see slides 40-41).

Chair reminded the task force of the information of the social event.

Meeting adjourned at 5:49 p.m. CEST.

Attendees (per IMAT and Webex attendance lists)

	Last Name	First Name	Affiliation	Employer
1	Alloin	Laurent		Ciena Corporation
2	Bang	Juneho		Huawei Technologies Duesseldorf GmbH
3	Bernier	Eric	Huawei Technologies Canada Co., Ltd.	Huawei Technologies Canada Co., Ltd.
4	Boyer	Rich	Aptiv - Signal and Power Solutions	Aptiv Signal and Power Solutions
5	Chen	Chan Chih (David)	Self Employed	Independent/AOI
6	Choudhury	Mabud	Genuine Optics	Genuine Optics
7	Cole	Christopher	Finisar Corporation	Coherent Corp.
8	Dawe	Piers J G	NVIDIA	Nvidia
9	El-Chayeb	Ahmad	Keysight Technologies Inc	Keysight Technologies Inc

10	Engenhardt	Klaus		Teradyne, Inc. & Quantifi Photonics
11	Fan	Xiaojie	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
12	Galan	Jose	MaxLinear, Inc.	MaxLinear, Inc.
13	Geng	Limin	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
14	HE	MICHAEL	TeraHop Pte. Ltd.	TeraHop Pte. Ltd.
15	Houck	TJ	Infineon Technologies	Infineon Technologies
16	Huang	Kechao	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
17	Huang	Mike	Berxel	Berxel
18	HUANG	QINHUI	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
19	Irwin	Scott	MoSys, Inc.	ADTRAN Inc.
20	Isono	Hideki	Furukawa FITEL Optical Components Limited	Furukawa FITEL Optical Components
21	Issenhuth	Tom	Issenhuth Consulting, LLC	Huawei Technologies Co., Ltd
22	Jackson	Kenneth	Sumitomo Electric Industries, LTD	Sumitomo Electric Industries, LTD
23	Jones	Chad	Cisco	Cisco
24	Johnson	John	Broadcom Corporation	Broadcom Corporation
25	Kagami	Manabu	Nagoya Institute of Technology	Nagoya Institute of Technology (NITech)
26	Kandarpa	Venkata	Chelsio Communications	NXP Semiconductors
27	KATO	TAKAHIRTO	Dexerials	Dexerials
28	Kim	Gyudong	Analog Devices Inc.	Analog Devices Inc.
29	Kimber	Mark	Semtech Ltd	Semtech Ltd
30	Landry	Gary	Coherent Corp.	Coherent
31	Lewis	David	SPECIPHY / Lumentum	SPECIPHY, LUMENTUM

32	Li	Jing	YOFC	YOFC
33	Maki	Jeffery	Hewlett Packard Enterprise	Hewlett Packard Enterprise
34	Maniloff	Eric	Ciena Corporation	Ciena Corporation
35	Mascitto	Marco	Infinera Canada Inc.	Nokia
36	mi	guangcan	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
37	Mitcheltree	Tom	US Conec, Ltd.	US Conec, Ltd.
38	Mueller	Thomas	Rosenberger	Rosenberger
39	Murty	Ramana	Broadcom Inc.	Broadcom Corporation
40	Ninomiya	Tiger	Accelink USA Corporation	Accelink USA Corporation
41	Palkert	Thomas	Samtec, Inc.	Samtec, Inc.
42	Park	Pusik		Korea Electronics Technology Institute (KETI);
43	Parsons	Earl	CommScope Amphenol	CommScope, Inc.
44	Ransford	Michael		Corning Incorporated
45	Razavi	Alireza	Marvell	Infineon Technologies
46	Rodes	Roberto	II-VI	II-VI
47	Rysin	Alexander	NVIDIA	NVIDIA
48	Schreiner	Stephan	Rosenberger	Rosenberger
49	Simms	Bill	NVIDIA	NVIDIA
50	Sharma	Rohit	Molex	Molex
51	Sheffi	Nir	Qualcomm	Qualcomm
52	Takahara	Tomoo	1FINITY	1FINITY
53	Torres	Luisma	Knowledge Development for POF SL	KD
54	Vanderlaan	Paul	UL Solutions	Panduit Corp.

55	Wang	Haojie	China Mobile Communications Corporation (CMCC)	China Mobile Communications Corporation (CMCC)
56	XU	LI	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
57	xu	wenxiong	HG Genuine	HGGenuine
58	Xu	Yu	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
59	Zerna	Conrad	Aviva Links Inc	NXP Semiconductors
60	ZHANG	KAN		China Mobile (Chengdu) Information and Telecommunication